

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT5715268

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAOYA OKAMURA	09/04/2019
TAKUMI TSUJISHITA	08/14/2019
MASANORI FUJII	09/02/2019
RECEIVING PARTY DATA	
Name:	HITACHI, LTD.
Street Address:	6-6, MARUNOUCHI 1-CHOME, CHIYODA-KU,
City:	TOKYO
State/Country:	JAPAN
Postal Code:	100-8280
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16568590
CORRESPONDENCE DATA	
Fax Number:	(703)684-1157
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-684-1120
Email:	svannarath@mmiplaw.com
Correspondent Name:	MATTINGLY & MALUR, PC
Address Line 1:	1800 DIAGONAL ROAD
Address Line 2:	SUITE 210
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	WL-12317
NAME OF SUBMITTER:	SHRINATH MALUR
SIGNATURE:	/Shrinath Malur/
DATE SIGNED:	09/12/2019
Total Attachments: 3	
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi, Ltd.,
a corporation organized under the laws of Japan,
located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo 100-8280 Japan
receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd.,
its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

COMPUTER SYSTEM AND DEVICE MANAGEMENT METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,
to be held and enjoyed by said Hitachi, Ltd.
its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Naoya Okamura Naoya OKAMURA

2019/9/4

2) _____ Takumi TSUJISHITA

3) _____ Masanori FUJII

4) _____

5) _____

6) _____

7) _____

8) _____

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1) _____ Naoya OKAMURA

2) Takumi Tsujishita Takumi TSUJISHITA

8/14/2019

3) _____ Masanori FUJII

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Date Signed
(署名日)

1) _____	Naoya OKAMURA	_____
2) _____	Takumi TSUJISHITA	_____
3) <u>Masanori Fujii</u>	Masanori FUJII	<u>Sep. 2nd, 2019</u>
4) _____		_____
5) _____		_____
6) _____		_____
7) _____		_____
8) _____		_____